

# High-Quality Epitaxial Five-Layer Aurivillius Films with In-Plane Ferroelectricity for Electrocaloric Cooling

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High-quality purely *c*-axis oriented epitaxial thin films of the Aurivillius phase  $\text{Sr}_2\text{Bi}_4\text{Ti}_5\text{O}_{18}$  with  $n = 5$  ( $\text{Sr,Bi}$ ) $\text{TiO}_3$  perovskite-like layers, are grown on  $\text{SrTiO}_3$  substrates by pulsed laser deposition. The highest crystalline quality is obtained with a 20 wt.% Bi-excess target and average stacking order values in the proximity of the ideal value  $n = 5$  are attained for an optimum deposition temperature of 650 °C. Scanning transmission electron microscopy reveals regions with  $n$  ranging from 4 to 6 around an average thickness of  $n = 5$ , in agreement with the X-ray diffraction analysis. Interdigital electrodes are used to probe the in-plane polarization and survey the electrocaloric properties. A maximum adiabatic temperature change of  $\Delta T \sim 0.95$  °C for an electric field of  $150 \text{ kV cm}^{-1}$  is observed at  $\approx 135$  °C. Larger values are expected at higher temperatures around the ferroelectric Curie temperature,  $T_C$ . Since  $T_C$  of  $\text{Sr}_2\text{Bi}_4\text{Ti}_5\text{O}_{18}$  can be tuned by codoping, the findings pave the way toward a large electrocaloric effect at ambient temperature.

## 1. Introduction

The electrocaloric effect (ECE) observed in solid-state ferroelectric materials presents an efficient and environmentally friendly alternative to the conventional vapor compression technology for refrigeration applications near room temperature.<sup>[1–4]</sup> Electrocaloric (EC) materials exhibit reversible adiabatic temperature ( $\Delta T$ ) and isothermal entropy ( $\Delta S$ ) changes, in response to electric field variations  $\Delta E$ , enabling the development of a thermodynamic cycle suitable for either cooling or also heating applications. EC materials have been in the spotlight since the mid-2000s, following the observation of a giant ECE in a thin film of the perovskite oxide

$\text{PbZr}_{0.95}\text{Ti}_{0.05}\text{O}_3$ , reaching  $\Delta T \sim 12$  °C (for  $\Delta E = 480 \text{ kV cm}^{-1}$ ) near its ferroelectric Curie temperature,  $T_C \sim 222$  °C.<sup>[5]</sup> They are advantageous over the considerably more well-developed magnetocaloric materials because of the easier application and higher efficiency of  $E$  fields compared to magnetic fields, which makes EC coolers compact in volume and suitable for miniaturization. In the last years, an extraordinary evolution in the  $\Delta T$  response has been reported, reaching up to 45 °C ( $\Delta E = 598 \text{ kV cm}^{-1}$ ) at room temperature in a Ba-doped  $\text{PbZrO}_3$  thin film.<sup>[6]</sup> Besides, the predicted high efficiency of 60–70% in energy conversion has recently been experimentally demonstrated in an EC device based on a  $\text{PbSc}_{0.5}\text{Ta}_{0.5}\text{O}_3$  multilayer capacitor.<sup>[7]</sup>

Ferroelectric thin films promote strong  $\Delta T$  responses as they withstand higher  $E$  fields than bulk systems, since the latter are limited by electrochemical breakdown due to different microstructural imperfections (porosity, microcracks, etc.).<sup>[8]</sup> Besides, the small volume of thin films makes them particularly attractive for localized thermal management and hence they have a great potential for on-chip EC cooling of electronic devices (e.g., in data centers).<sup>[3,9]</sup> To date, as shown by the previously mentioned examples, the largest  $\Delta T$  values have mainly been obtained in lead-containing perovskite thin films.<sup>[10]</sup> However, the use of toxic lead poses environmental barriers toward implementing widespread cooling and heating applications. In line with European directives,<sup>[11]</sup> hazardous lead must be avoided. Thus, progressing in the field of EC cooling urges the need of developing lead-free potential refrigerant materials.

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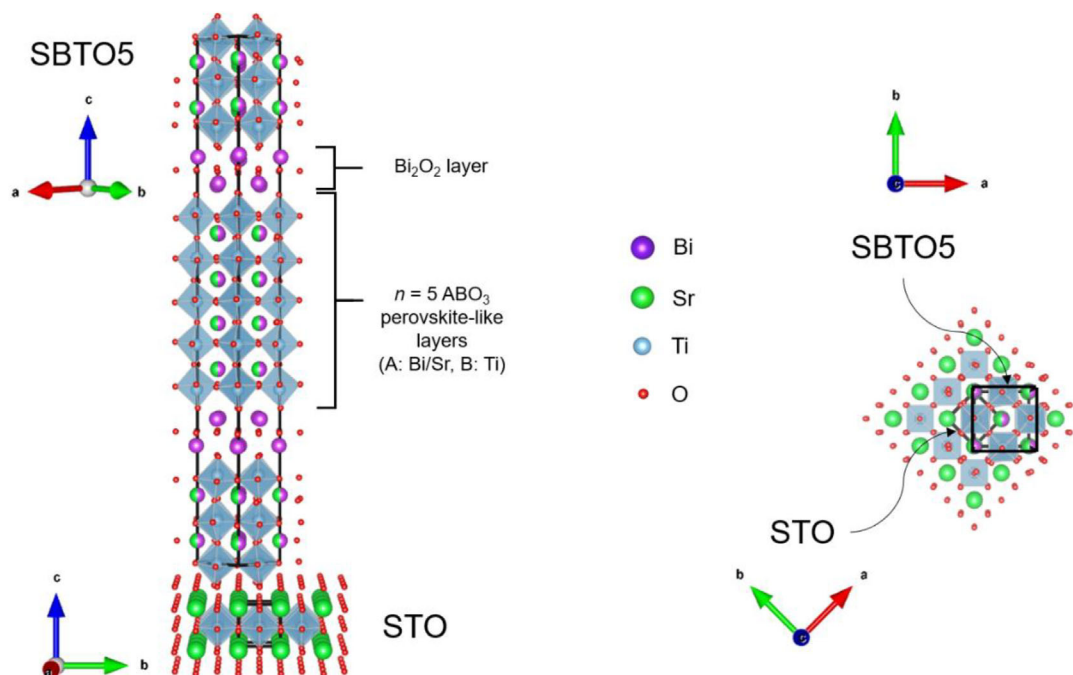
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**Figure 1.** Schematic of the  $n = 5$  Aurivillius phase  $\text{Sr}_2\text{Bi}_4\text{Ti}_5\text{O}_{18}$  (SBT05) unit cell in relation to that of the  $\text{SrTiO}_3$  (STO) substrate along two different views: lateral (left) and top (right). SBT05 has an orthorhombic crystal structure ( $B2cb$  space group) at room temperature, which is nearly tetragonal with  $a \sim b \approx 5.46$  Å, being  $c \approx 48.85$  Å.<sup>[27]</sup> The lattice parameter of SBT05 assuming a pseudotetragonal structure is 3.861 Å, which shows a small  $\approx 1\%$  mismatch with the lattice constant of cubic STO ( $a = 3.905$  Å) and favors the growth of the Aurivillius phase with the in-plane lattice parameter along the  $[110]$  direction on the STO surface. Figure prepared with VESTA.<sup>[28]</sup>

Lead-free Aurivillius phases with general chemical formula  $\text{Bi}_2\text{A}_{n-1}\text{B}_n\text{O}_{3(n+1)}$ , also known as bismuth layered structure ferroelectrics, have been recognized as promising candidates for EC cooling because of their high dielectric strength, low leakage current and endurance upon  $E$  field cycling.<sup>[1,12,13]</sup> They are composed by  $n$  perovskite-like layers ( $\text{A}_{n-1}\text{B}_n\text{O}_{3n+1}$ )<sup>2-</sup> sandwiched between bismuth oxide layers ( $\text{Bi}_2\text{O}_2$ )<sup>2+</sup> along the  $c$ -axis, being the  $c$  cell parameter much larger than  $a$  and  $b$  (Figure 1). The high-temperature crystal structure in the paraelectric phase is tetragonal ( $I4/mmm$  space group). Complex polar structures, typically orthorhombic ( $A2_1am$  space group for even  $n$ ,  $B2cb$  space group for odd  $n$ ), which involve not only the B-cation like in  $\text{BaTiO}_3$  and other simple perovskites but also the A-cation and oxygens, originate below  $T_C$ .<sup>[1,11,14]</sup> The layered structure of Aurivillius phases results in highly anisotropic electrical properties, with a quasi 2D polarization lying in the  $ab$  plane.<sup>[15]</sup> More specifically, in the orthorhombic structures ( $A2_1am$  and  $B2cb$  space groups) the polarization lies entirely along the  $a$ -axis.<sup>[16]</sup>

Despite their potential for EC thermal control applications, the ECE of Aurivillius oxides remains largely unexplored. The few dedicated studies primarily focused on three-layer ( $n = 3$ ) Aurivillius compositions with Nb and/or Ta at the B-site. Given the inherently high  $T_C$  values of Aurivillius phases, chemical substitutions were applied in bulk  $n = 3$  Aurivillius phases to adjust  $T_C$ , and thereby optimize the ECE,<sup>[17]</sup> closer to room temperature. For instance,  $\text{SrBi}_2(\text{Nb}_{0.2}\text{Ta}_{0.8})_2\text{O}_9$  was investigated with  $\text{Pr}^{3+}$  and  $\text{Ba}^{2+}$  doping separately,<sup>[18–20]</sup> yielding maximum  $\Delta T$  values of  $\approx 0.5$  °C ( $\Delta E = 55$  kV cm<sup>-1</sup>) and  $\approx 0.8$  °C ( $\Delta E =$

50 kV cm<sup>-1</sup>), respectively, near 140 °C. Lower-temperature ECE peaks were obtained in  $\text{SrBi}_{1.98}\text{La}_{0.02}\text{Nb}_{2-x}\text{Ta}_x\text{O}_9$  ( $x = 0.5, 1.0, 1.5$ ) compositions,<sup>[21]</sup> though with much smaller  $\Delta T$  values of  $\approx 0.005$  °C ( $\Delta E = 35$  kV cm<sup>-1</sup>). The only study of EC properties in Aurivillius thin films reported a large  $\Delta T \sim 5$  °C ( $\Delta E = 600$  kV cm<sup>-1</sup>) in a polycrystalline film of  $\text{SrBi}_2\text{Ta}_2\text{O}_9$  around its  $T_C \sim 290$  °C.<sup>[22]</sup>

Encouraged by the trend of decreasing  $T_C$  values upon increasing the number of perovskite-like layers in the B = Ti Aurivillius family  $\text{Sr}_{n-3}\text{Bi}_4\text{Ti}_n\text{O}_{3n+3}$  (with  $T_C$  values of 675, 520 and 285 °C for  $n = 3, 4$  and 5, respectively),<sup>[23]</sup> we recently investigated the EC properties of the lowest  $T_C$  member, five-layer  $\text{Sr}_2\text{Bi}_4\text{Ti}_5\text{O}_{18}$ , in its bulk form. By employing La/Nb codoping, we could tune the ECE near room temperature, reaching a maximum  $\Delta T \sim 0.3$  °C ( $\Delta E = 37$  kV cm<sup>-1</sup>) at 80 °C for the optimum composition  $\text{Sr}_2\text{Bi}_{3.44}\text{La}_{0.5}\text{Ti}_{4.8}\text{Nb}_{0.2}\text{O}_{18}$ .<sup>[24]</sup> Building on these findings, the next step to enhance the EC performance of these materials is to fabricate them in thin-film form, aiming for a higher dielectric strength and thus stronger ECE.<sup>[8]</sup> Given the complexity of these five-layer Aurivillius phases in terms of both composition and structure, a reasonable approach is to tackle first the investigation of the parent compound,  $\text{Sr}_2\text{Bi}_4\text{Ti}_5\text{O}_{18}$  (hereinafter denoted SBT05). We also note that, in the general Aurivillius family  $\text{Sr}_{n-3}\text{Bi}_4\text{Ti}_n\text{O}_{3n+3}$ , there is a dependence of the ferroelectric remanent polarization on the parity of  $n$ , as reported in previous works on bulk<sup>[25]</sup> and thin-film<sup>[26]</sup> forms, with polarization values being larger for odd  $n$  than for even  $n$ . The primary motivation for selecting the  $n = 5$  Aurivillius phase SBT05 over the less complex lower- $n$  analogues lies in a balance between  $T_C$  and polarization

values, considering the target cooling applications near ambient temperature.

The  $n = 5$  SBT05 Aurivillius phase exhibits an orthorhombic structure with space group  $B2cb$  at room temperature (Figure 1), and thus its ferroelectric polarization lies entirely along the  $a$ -axis. The high anisotropy in its electrical properties makes the fabrication of single-crystalline epitaxial thin films particularly appealing, as these can potentially yield a greater polarization response than randomly oriented polycrystalline thin films. As compared to  $a$ - and  $b$ -axis oriented epitaxial Aurivillius films,  $c$ -axis oriented films are generally easier to produce due to the favorable structural matching with the  $ab$ -plane of commercial perovskite single crystals. Nevertheless, achieving high-quality epitaxial Aurivillius films is challenging due to several difficulties. First, the precise control of the Bi composition is complicated by the high deposition temperatures required for epitaxial growth and the volatility of Bi-containing compounds. Second, the wide compositional variation along the  $c$ -axis can lead to the formation of structural defects, such as out-of-phase boundaries (OPBs) or the intergrowth of other- $n$  Aurivillius phases.<sup>[16,29–32]</sup> Furthermore,  $c$ -axis oriented epitaxial Aurivillius films face the limitation that standard bottom-top electrode configurations cannot probe the in-plane polarization.

Herein, we first present the optimization of the growth conditions for high-quality SBT05 Aurivillius epitaxial thin films, which we grow on [001]-oriented SrTiO<sub>3</sub> (STO) single-crystal substrates through pulsed laser deposition (PLD). Assuming a pseudotetragonal structure, the lattice parameter of SBT05 is 3.861 Å, which shows a small  $\approx 1\%$  mismatch with the lattice constant of cubic STO ( $a = 3.905$  Å), facilitating cube-on-cube growth of the corresponding perovskite-like blocks. That is, the Aurivillius phase grows with the in-plane  $a$ - and  $b$ -axes aligned along the [110] directions on the STO surface (Figure 1). To counteract Bi volatility, dense ceramic targets containing 10 and 20 wt.% excess of the Bi<sub>2</sub>O<sub>3</sub> precursor were used. In addition, we examined deposition temperature ( $T_{\text{dep}}$ ) values in the range 650–800 °C. We subsequently investigated the in-plane ferroelectric and EC properties of the resultant films using top interdigital electrodes (IDEs), fabricated by optical lithography and Cr/Au evaporation. We note that the experimental investigations into the EC properties of epitaxial thin films are rare, particularly those utilizing non-standard planar electrode geometries like IDEs.<sup>[33,34]</sup> In the present Aurivillius films, the IDEs have facilitated the observation of well-saturated remanent hysteresis loops at room temperature, confirming the presence of ferroelectricity and yielding a maximum ECE response of  $\Delta T \sim 0.95$  °C ( $\Delta E = 150$  kV cm<sup>-1</sup>) at  $\approx 135$  °C. Notably, this exceeds the maximum  $\Delta T$  response previously achieved in bulk SBT05 upon doping, which was only  $\approx 0.27$  °C ( $\Delta E = 37$  kV cm<sup>-1</sup>) at  $\approx 80$  °C.<sup>[24]</sup> While this performance may be considered moderate compared to the giant ECE values reported for other ferroelectric perovskite thin films,<sup>[9,35]</sup> we anticipate that a significantly higher ECE could be realized at temperatures closer to  $T_C$ . This work also provides insights on critical considerations when using IDEs for assessing the ferroelectric and EC properties of epitaxial thin films, particularly regarding the substrate material selection and its impact on the electrical properties of the films.

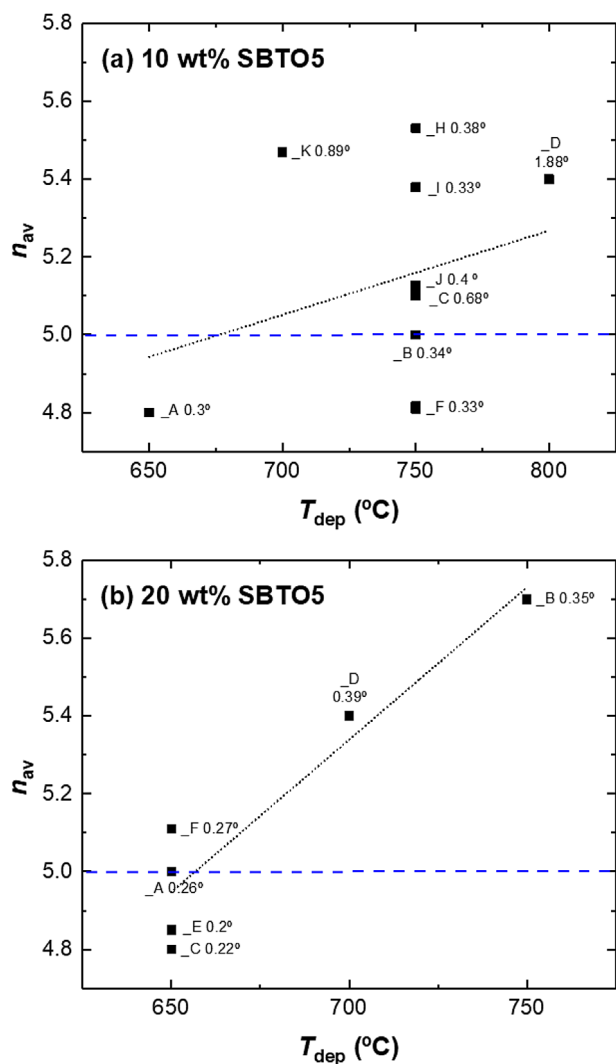
## 2. Results and Discussion

Several thin films of the two available targets were fabricated at different  $T_{\text{dep}}$  values in order to find the optimum growth conditions leading to high-quality  $c$ -axis oriented epitaxial SBT05 (see Table S1, Supporting Information for a full detailed list, and Figure S1, Supporting Information for a selection of X-ray reflectivity data). We first focused on the lowest Bi-excess target, 10 wt.% SBT05. Figure 2a shows the X-ray diffraction (XRD) patterns of the films deposited at  $T_{\text{dep}}$  equal to 650, 750 and 800 °C. At first inspection of the full diffractograms, only 00 $l$  reflections with even  $l$  values besides the STO reflections are detected, which is compatible with single-phase and highly  $c$ -axis oriented epitaxial SBT05 Aurivillius films. No trace of a different orientation was detected. Regarding the evolution upon increasing  $T_{\text{dep}}$ , the high crystalline quality evident from the narrow peaks in the patterns corresponding to 650 and 750 °C, gets significantly worse at 800 °C. Concerning the surface morphology of these samples, a reasonably low root mean square roughness value  $\leq 2$ –3 nm was derived for all the films from the 1  $\mu\text{m} \times 1$   $\mu\text{m}$  size atomic force microscopy (AFM) topography scans (see Figure S2, Supporting Information). However, the uniform and dense granular structure obtained for 650 and 750 °C shows an additional distribution of islands for 800 °C. Based on the similarity with the distribution of cuboids detected at early stages of growth in related epitaxial  $n = 4$  Bi<sub>5</sub>FeTi<sub>3</sub>O<sub>15</sub> films,<sup>[30]</sup> we speculate that the islands observed in the highest deposition temperature film could be due to an improper coalescence of the perovskite slabs due to defects like OPBs. Regarding the 20 wt.% SBT05 target, and taking the previous conclusion as a starting point, an intermediate  $T_{\text{dep}}$  value of 700 °C was checked, as the value of 800 °C was considered too high to yield high-quality films. Figure 2b shows the XRD patterns of the films deposited at  $T_{\text{dep}}$  equal to 650, 700, and 750 °C from the highest Bi-excess target. In this case, all the films seem single-phase and highly  $c$ -axis oriented with a more comparable high crystalline quality among them, being the pattern corresponding to 650 °C the one showing the sharpest peaks.

Having achieved this high-quality of SBT05 Aurivillius films allows us to extract further quantitative information from the XRD data and establish an optimum  $T_{\text{dep}}$ . Upon closer inspection of the XRD patterns in the detail regions shown in Figure 2a,b, in addition to the presence of a minor secondary phase indicated with # symbol ( $\delta$ -Bi<sub>2</sub>O<sub>3</sub> bixbyite), one can observe that some of the 00 $l$  peaks shift to either higher or lower angles between films, which is a sign of intermixing of regions along the  $c$ -axis with periodicities deviating from the nominal  $n = 5$  stacking order.<sup>[36]</sup> This intermixing is further evidenced by the doubling of certain particular peaks (i.e., 006, 0018, 0030 and 0042) in some of the films deposited from both targets. Following the same methodology as described in ref.[36] we have derived the average stacking order  $n_{\text{av}}$  achieved in each film from the relative displacements between adjacent peaks in the diffractogram using the following general expression:  $n_{\text{av}} = \frac{12}{l} \times [Q_l / (Q_l - Q_{l-2})] - 1$ , applied to a representative subset of reflections with  $l = 12, 24, 36$  and 48, in relation to the corresponding set  $l-2 = 10, 22, 34$  and 46. Figure 3 shows the representation of the  $n_{\text{av}}$  parameter versus  $T_{\text{dep}}$  for the films grown with the 10 wt.% and 20 wt.% targets separately. In addition, we have also included the information from the full width at half maximum (FWHM) of the peak







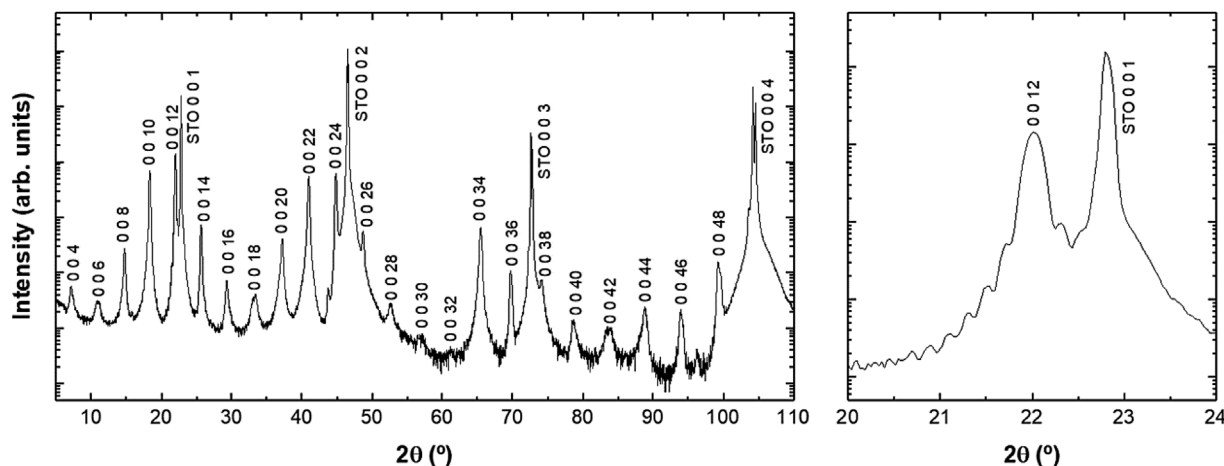
**Figure 3.** Calculated average stacking number  $n$  parameter from the XRD data versus the deposition temperature for selected films grown using the a) 10 wt.% and b) 20 wt.% SBT05 targets. The dotted lines indicate the results of the linear regression, while horizontal blue dashed lines indicate the ideal  $n = 5$  value. Next to each symbol, it appears indicated a label related to the sample name (Table S1, Supporting Information) followed by the value of the full width at half maximum of a selected diffraction peak as described in the text.

around STO 3 0 3 and 1 1 3 peaks ( $\phi = 0$  and  $45^{\circ}$ , respectively) where the  $Q_x$  positions of the corresponding SBT05 reflections, 3 3  $l$  with odd  $l$  and 3 0  $l$  with even  $l$  respectively, are in perfect coincidence, showing that the film is fully strained in-plane. Furthermore, the absence of a visible peak splitting in the RSMs indicates that we do not detect a differentiation between the orthorhombic  $a$  and  $b$  in-plane lattice parameters, which can be ascribed to a tetragonal structure in the film due to the strain or also to the presence of nanometer-size  $a$ - $b$  crystal twinning, which makes it difficult to be resolved with standard lab diffractometers.

The crystal quality of optimized films was also assessed by high-angle annular dark-field scanning transmission electron microscopy (STEM-HAADF) cross-section images as shown in

**Figure 6.** The film deposited under optimized conditions shows a clear layered structure with the pure  $c$ -axis orientation. Neither secondary phases nor domains with different orientations were observed in the analyzed regions. As it can be observed in Figure 6a, the interface with STO substrate is sharp, while top surface morphology shows roughness of  $\approx 2$ –3 nm, in consistency with the AFM analysis. The atomic resolution of the image evidences the sequence of the double  $\text{Bi}_2\text{O}_2$  layers and  $(\text{Sr},\text{Bi})\text{TiO}_3$  perovskite blocks along the growth direction parallel to  $c$ -axis. The higher magnification image of one zone of the SBT05 film in Figure 6b shows the presence of a large density of stacking faults, indicated with yellow arrows, which interrupt the continuity of the  $\text{Bi}_2\text{O}_2$  layers in the horizontal direction forming well defined steps in the vertical direction. The continuity of the perovskite layers in the lateral direction is not affected. Therefore, the stacking defects can be considered as OPBs consisting of one single perovskite cell translation of the structure in the  $c$ -axis direction, as often observed in Aurivillius-type structures.<sup>[29,32]</sup> The regions between these OPBs define slabs with an integer number of perovskite blocks ranging from 4 to 6, around an average thickness of  $n = 5$ , in agreement with the  $n_{\text{av}}$  parameter value derived from the XRD analysis in the same film. In the zone axis orientation of the cut, parallel to the  $[100]/[010]$  directions of the STO substrate, the perovskite blocks are equally oriented, which indicates a fully coherent growth of the film. The presence of the  $\text{Bi}_2\text{O}_2$  layers produces a change in the stacking sequence of the perovskite blocks with an in-plane one-half-perovskite unit translation along the  $[100]$  direction, irrespectively of the  $n$  number of the perovskite slab, as expected for the Aurivillius-type structure. Altogether, this preserves the monolithic structure of the film despite the presence of the OPB defects. These OPBs do not seem to be related to any step in the substrate surface, and are probably generated by local fluctuations of the Bi-concentration during film growth, at least in the early stages.

Next, we evaluate the ferroelectric and EC properties in a selection of our high-quality  $c$ -axis oriented epitaxial SBT05 Aurivillius films grown using the 20 wt.% Bi-excess target. In particular those with  $n_{\text{av}}$  in the vicinity of the  $n = 5$  ideal value, and having different thicknesses: 74 nm ( $n_{\text{av}} = 5.0$ ),  $\approx 250$  nm ( $n_{\text{av}} = 4.8$ ) and 40 nm ( $n_{\text{av}} = 5.4$ ), namely samples SBT05\_20\_A, SBT05\_20\_C and SBT05\_20\_D, respectively, in Table S1 (Supporting Information). The assigned thickness value is deduced from the corresponding X-ray reflectivity (XRR) measurements except for the thickest sample, whose thickness was assumed from a rough estimation of the growth rate as to 0.1 nm per pulse following the results from XRR in a very thin sample (Figure S1, Supporting Information). Standard hysteresis measurements (Figure S5, Supporting Information) yield very large polarization values at high  $E$  field amplitudes, particularly for thinner films, while a distinct ferroelectric opening is only detected for the thickest film. This is likely attributed to the influence of the linear dielectric contribution from the STO substrate on the measured polarization, which becomes increasingly significant with thinner films. Due to potential substrate effects, the electrical measurements using surface IDEs are more complex than those with bottom-top electrode configurations, especially when interacting with a high-permittivity material such as STO.<sup>[37–40]</sup> A useful approach to effectively differentiate the intrinsic ferroelectric contributions in thin films, is the application of the remanent hysteresis



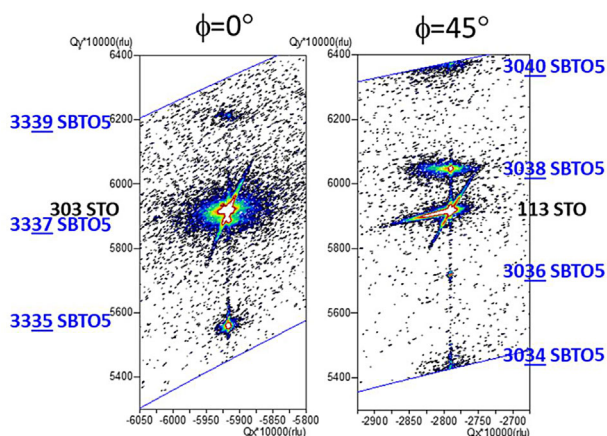
**Figure 4.**  $\theta$ - $2\theta$  X-ray diffraction full pattern (left) and detail region (right) of a film grown in optimal conditions using the 20 wt.% SBT05 target and deposition temperature  $T_{\text{dep}} = 650^\circ\text{C}$  (sample SBT05\_20\_F, see Table S1, Supporting Information), illustrating the presence of Laue oscillations around the SBT05 peaks in agreement with a thickness of 46 nm.

protocol based on the well-known PUND method.<sup>[41]</sup> This approach enables the separation of switching polarization (i.e., the film intrinsic ferroelectric polarization) from non-switching polarization (i.e., linear dielectric contributions and leakage currents). Further details about the remanent hysteresis protocol are given in Figure S6 (Supporting Information).

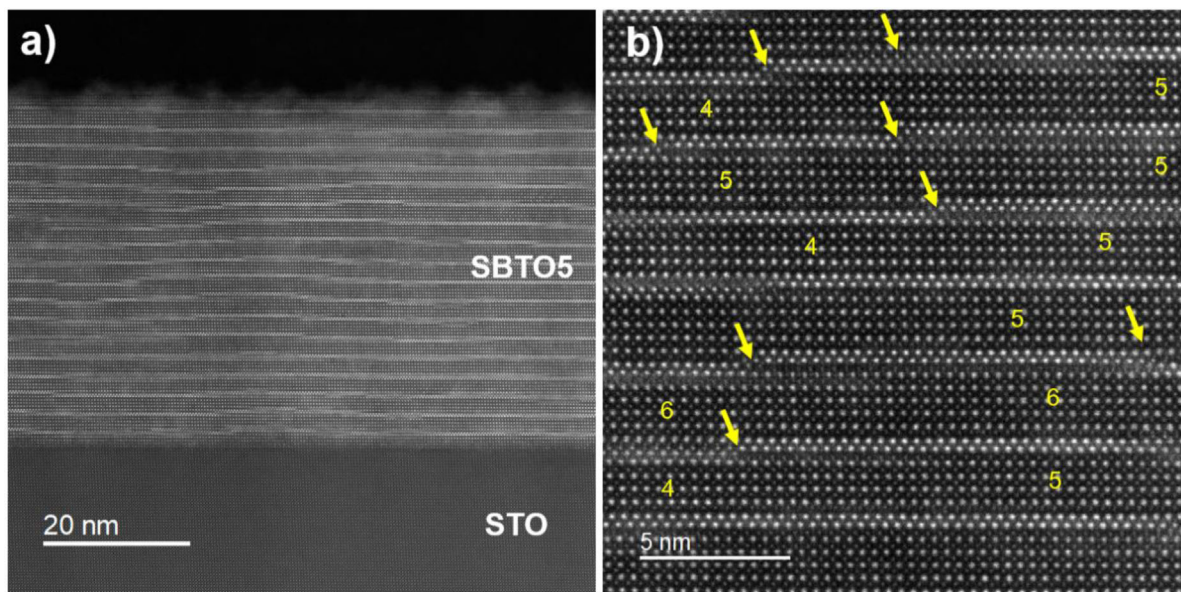
**Figure 7** shows the  $P(E)$  results at room temperature, derived from remanent hysteresis measurements on the selected films with an  $E$  field amplitude  $E_0 = 150\text{ kV cm}^{-1}$ . We observe clear hysteresis loops that confirm an intrinsic in-plane ferroelectricity in the selected SBT05 Aurivillius films. Switching coercive fields  $E_C \approx 60\text{ kV cm}^{-1}$  and zero-field remanent polarization  $P_r \approx 6\text{--}8\text{ }\mu\text{C cm}^{-2}$  are found without evident systematic dependence on the film thickness or  $n_{\text{av}}$ . We note that the presence of intergrowths revealed by the STEM-HAADF images can affect the fer-

roelectric properties in the following ways: i) disruption of the long-range order of dipoles caused by the structural and compositional disorder, leading to reduced polarization and pinning effects that hinder the motion of ferroelectric domain walls, resulting in an increased  $E_C$ , as well as local strain fields and distortions that can either enhance or weaken the polarization; and ii) given the dependence of the polarization on the parity of  $n$  in the general Aurivillius family  $\text{Sr}_{n-3}\text{Bi}_4\text{Ti}_n\text{O}_{3n+3}$ , with polarization values being larger for odd  $n$  than for even  $n$ , a reduced polarization could be expected in films with  $n_{\text{av}} < 5$  or  $n_{\text{av}} > 5$ , following the trend of  $P_r$  as a function of  $n$ .<sup>[26]</sup> In general, we observe larger polarization values in films where  $n_{\text{av}} \geq 5$ , while slightly smaller values are found in films with  $n_{\text{av}} < 5$ . The polarization curve of a thick sample grown using the 10 wt.% SBT05 target (thickness  $\approx 200\text{ nm}$ ,  $n_{\text{av}} = 4.8$ ) agrees reasonably well with the analogous film using the 20 wt.% target, as shown in Figure S7 (Supporting Information). Moreover, we observe a higher  $E_C$  magnitude compared to previous works in both thin-film<sup>[42,43]</sup> and bulk<sup>[24,25]</sup> forms, which is slightly larger for films with  $n_{\text{av}} < 5$  or  $n_{\text{av}} > 5$ . Therefore, our results indicate a clear effect of the structural and compositional disorder on the ferroelectric properties, with a resulting polarization that cannot be simply predicted by the expected polarization values for a given  $n$ . This is also consistent with the disorder in the distribution of intergrowths, as identified by STEM-HAADF. Despite the presence of intergrowths, it is remarkable that our  $P_r$  values measured using surface IDEs exceed those previously reported for  $c$ -axis oriented epitaxial SBT05 films probed using standard bottom-top electrodes and  $E$  fields up to  $200\text{ kV cm}^{-1}$  ( $\approx 5\text{ }\mu\text{C cm}^{-2}$  for Pt/SBT05/Pt and  $\approx 0.9\text{ }\mu\text{C cm}^{-2}$  for Pt/SBT05/SrRuO<sub>3</sub>)<sup>[42]</sup> or even up to  $400\text{ kV cm}^{-1}$  ( $\approx 2.5\text{ }\mu\text{C cm}^{-2}$  for Pt/SBT05/LaNiO<sub>3</sub>/LaAlO<sub>3</sub>).<sup>[43]</sup> Additionally, our measurements reveal well-saturated hysteresis loops, unlike the reported  $P(E)$  curves measured with bottom-top electrodes ( $E_C \approx 50\text{ kV cm}^{-1}$ ).<sup>[42,43]</sup>

We also observe that, the thinner the sample, the noisier the remanent hysteresis curve appears (Figure 7). This can be anticipated since it represents a small fraction of the total measured polarization. For this reason, we next focus on the film with the

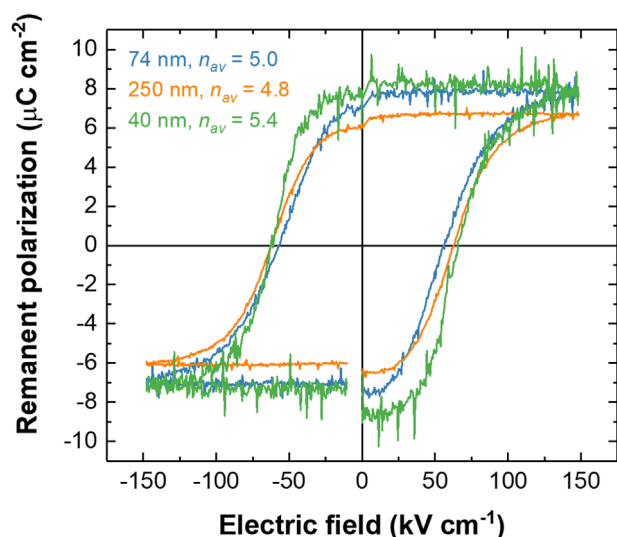


**Figure 5.** Reciprocal space maps around STO 303 (right) and 113 (left) peaks of a film grown in optimal conditions using the 20 wt.% SBT05 target and deposition temperature  $T_{\text{dep}} = 650^\circ\text{C}$  (sample SBT05\_20\_E, see Table S1, Supporting Information). The perfect coincidence of  $Q_x$  values between SBT05 film and STO substrate shows that the film is fully strained.



**Figure 6.** STEM-HAADF cross-section images of a film grown in optimal conditions using the 20 wt.% SBT05 target and deposition temperature  $T_{\text{dep}} = 650\text{ °C}$  (sample SBT05\_20\_F, see Table S1, Supporting Information), with a thickness of 46 nm: a) general overview including STO substrate; b) larger magnification image of the film. The arrows indicate stacking faults consisting of out-of-phase boundaries which correspond to a structure translation of one single perovskite block in the vertical  $c$ -axis direction. The image evidences regions with varying integer number of perovskite blocks around average  $n = 5$ .

cleanest remanent polarization signal, which is the thickest film ( $\approx 250\text{ nm}$  and  $n_{\text{av}} = 4.8$ ), for the thermodynamic analysis of the temperature-dependent  $P(E)$  data that leads to the derivation of the EC response as a function of temperature. Although this sample permitted slightly higher  $E$  field amplitudes, we have selected  $E_0 = 150\text{ kV cm}^{-1}$  as a suitable compromise between the achieved polarization values and the signal-to-noise ratio (Figure S8, Supporting Information). Figure 8 displays the in-plane remanent



**Figure 7.** In-plane polarization versus electric field curves applying the remanent hysteresis protocol at room temperature for selected films grown using the 20 wt.% SBT05 target having different thicknesses and average stacking order.

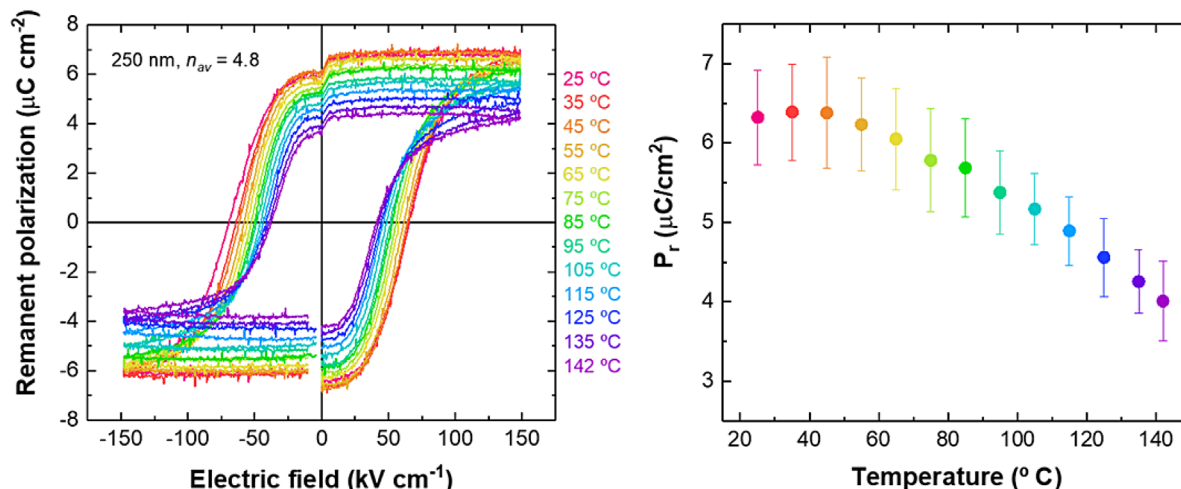
$P(E, T)$  data measured during heating, revealing a decreasing trend of polarization values with increasing temperature, as captured by the evolution of  $P_r$  as a function of temperature. Notably, even though  $P_r$  starts to decrease at  $\approx 60\text{ °C}$ , it remains significantly above the zero-value characteristic of the paraelectric phase within the temperature range studied. This observation is consistent with the fact that the film is still far from reaching its ferroelectric Curie temperature ( $T_C \sim 285\text{ °C}$  for bulk SBT05<sup>[23,24]</sup>).

The ECE figures of merit,  $\Delta S$  and  $\Delta T$ , obtained from applying Equations (1) and (3), respectively, to the remanent  $P(E, T)$  data of the thickest film grown with the 20 wt.% target, are shown in Figure 9 as a function of temperature and at various  $\Delta E$  values: 10, 50, 100, and  $150\text{ kV cm}^{-1}$ . The data indicate a noticeable upward trend in the  $-\Delta S(T)$  and  $\Delta T(T)$  dependences, suggesting that we are approaching a maximum around  $T_C$  that lies outside the temperature range accessible by our setup. This is consistent with the temperature evolution shown by  $P_r$  (Figure 8). Consequently, we observe the largest intrinsic ECE response at the upper limit of the examined temperature range, reaching  $\Delta T \sim 0.95\text{ °C}$  ( $\Delta E = 150\text{ kV cm}^{-1}$ ) at  $\approx 135\text{ °C}$ . We note that although the maximum temperature measured is still far from the  $T_C \sim 285\text{ °C}$  value of bulk SBT05, due to the distribution of intergrowths the film likely exhibits a diffuse ferroelectric transition and thus a broader ECE response over temperature, which explains the relatively high value of  $\Delta T$  at  $\approx 135\text{ °C}$ .

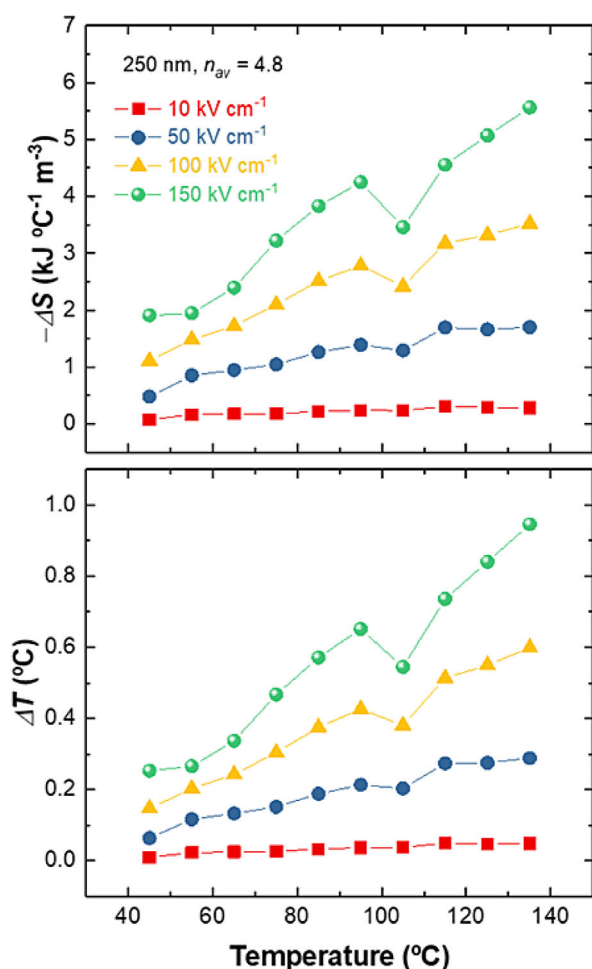
### 3. Conclusion

We have successfully grown high-quality  $c$ -axis epitaxial films of the complex  $n = 5$  SBT05 Aurivillius phase on STO substrates by PLD. Using a ceramic SBT05 target with a 20 wt.% Bi-excess, we achieved  $c$ -axis oriented films with remarkably good crystalline





**Figure 8.** In-plane polarization versus electric field curves applying the remanent hysteresis protocol as a function of temperature upon heating for the thickest film grown using the 20 wt.% SBT05 target (left) and evolution of the zero-field remanent polarization versus temperature from the same data (right).



**Figure 9.** Isothermal entropy (top) and adiabatic temperature (bottom) variations of the electrocaloric effect as a function of temperature at various  $E$  field values, calculated from the in-plane remanent  $P(E, T)$  data shown in Figure 8.

quality, closely aligning with the ideal  $n = 5$  value at an optimal deposition temperature of 650 °C. To investigate the in-plane ferroelectric and EC properties, we utilized surface IDEs. By applying the remanent hysteresis protocol to measure the in-plane polarization, we were able to distinguish the film intrinsic ferroelectric response from the strong linear dielectric contribution of the STO substrate. This method provided  $P_r$  values  $\approx 6\text{--}8 \mu\text{C cm}^{-2}$ , surpassing previously reported values for similar SBT05 films using conventional bottom-top electrode configurations. Our results highlight the importance of selecting low-permittivity substrate materials to minimize their influence on the characterization of in-plane polarization in ferroelectric thin films when using IDEs. Additionally, we measured the film intrinsic polarization as a function of temperature, revealing a maximum ECE of  $\Delta T \sim 0.95 \text{ °C}$  ( $\Delta E = 150 \text{ kV cm}^{-1}$ ) at  $\approx 135 \text{ °C}$ . Furthermore, we propose that the ECE could be further enhanced through modified compositions with lower  $T_C$  values, such as La/Nb codoped SBT05, which has a  $T_C$  near room temperature in its bulk form. The epitaxial growth of such compositions could be pursued, using the optimized conditions established in this work as a foundation.

## 4. Experimental Section

**Target Preparation:** Dense ceramic pellets of SBT05 prepared by the standard solid-state reaction method were used as Pulsed Laser Deposition (PLD) targets. Precursor powders of  $\text{Bi}_2\text{O}_3$ ,  $\text{SrCO}_3$ , and  $\text{TiO}_2$  with purities not less than 99.9% were used. Due to the high volatility of Bi, an excess of the  $\text{Bi}_2\text{O}_3$  precursor weight with respect to the stoichiometric requirement was applied, and two different targets were prepared with 10 and 20 wt.% Bi-excess. The stoichiometric amounts (with the exception of the mentioned wt.% of  $\text{Bi}_2\text{O}_3$  excess) were mixed and ground in a ball mill for 2 h. The powders were then calcined at 850 °C for 4 h. The resulting products were reground, pressed into pellets with 20 mm diameter under 10 Tons of uniaxial pressure, and sintered at 1190 °C for 4 h.

**Thin Film Growth:** SBT05 thin films were grown by PLD on commercial (001)-oriented STO single crystal substrates of  $5 \times 5 \times 0.5 \text{ mm}^3$  size (CrysTec GmbH). The substrates were cleaned sequentially in acetone,



ethanol and deionised water in an ultrasonic bath. The PLD processes were performed with a KrF excimer laser (248 nm, COMPex 102, Lambda Physik). The main experimental variables were the Bi-excess in the target (10 wt.% or 20 wt.% SBT05) and the substrate deposition temperature  $T_{\text{dep}}$  (see Table S1, Supporting Information for a full list of samples). Other variables like oxygen partial pressure  $P(\text{O}_2)$  or laser fluence were kept constant and the following common growth conditions were applied in the different films: 1) pre-ablation with 1000 pulses (same laser fluence as in the ablation, 10 Hz repetition rate) at room temperature, 2) heating at  $20^\circ\text{C min}^{-1}$  up to the selected  $T_{\text{dep}}$  in a dynamic  $P(\text{O}_2)$  of 100 mTorr, 3) ablation in the same  $P(\text{O}_2)$  with a laser fluence set at  $1.3\text{ J cm}^{-2}$  and 5 Hz repetition rate, 4) annealing after deposition for 10 min with a  $P(\text{O}_2)$  of 10 Torr, and 5) cooling down to room temperature at  $5^\circ\text{C min}^{-1}$  in the same  $P(\text{O}_2)$ .

**Structural and Morphological Characterization:** The structural characterization of the films was performed by X-ray diffraction (XRD)  $2\theta/\omega$  wide scans, X-ray reflectivity (XRR) and reciprocal space maps (RSMs) of selected asymmetric reflections, by using a four-circle X-ray diffractometer (Malvern-Panalytical X'pert Pro MRD) and standard  $\text{Cu K}\alpha_{1,2}$  X-ray source with a parabolic mirror (for reciprocal space maps, a  $2\text{xGe}(220)$  monochromator was added to the incident optics). A 2D array PIXcel detector was used. The topography of selected films was studied using atomic force microscopy (AFM) in contact mode (Keysight 5100) over different areas. The structure of the films was also analyzed by high-angle annular dark-field scanning transmission electron microscopy (HAADF-STEM) on a Fisher Spectra microscope operated at 200 kV. Cross-section lamellas were prepared by focused ion beam (FIB) on a SBT05 film deposited under optimized conditions, with the cut oriented to show STO [100] zone axis.

**Interdigital Electrodes:** IDEs were fabricated by means of optical lithography in a 100 class clean room facility and metal evaporation, going through several steps as reported elsewhere.<sup>[44]</sup> The fabricated IDEs consist of a  $\text{Cr}(20\text{ nm})/\text{Au}(150\text{ nm})$  bilayer and the pattern has three bonding paths with several fingers each, so the central one can couple to either side paths allowing two electrode pairs per sample. The  $E$  field is given by  $E = V/g$ , being  $V$  the applied voltage value and  $g$  the gap between fingers, while the total electrode area can be approximated by  $A \approx N \times l \times t$ , where  $N$  is the number of spaces between fingers,  $l$  the effective length of the fingers and  $t$  the film thickness.<sup>[38–40]</sup> The used pattern has  $g = 15\text{ }\mu\text{m}$  and consists of 38 fingers per bonding path, with a finger length and width of  $1200\text{ }\mu\text{m}$  and  $15\text{ }\mu\text{m}$ , respectively. Regarding the in-plane orientation geometry, for simplicity, the IDEs were placed such that the  $E$  field direction is parallel/perpendicular to the substrate lateral edges (i.e., the STO [100] or [010] directions). Given that the Aurivillius films grow with the in-plane lattice parameter along the STO [110] direction (and/or their equivalent directions), this configuration is also convenient because it assures the detection of the in-plane polarization along the  $a$ -axis. Since STO is cubic, no in-plane anisotropy is expected with respect to the orientation of the  $a$ - and  $b$ -axis of the Aurivillius phase. Further details can be found in Figure S9 (Supporting Information).

**Ferroelectric and Electrocaloric Properties:** These properties were investigated by measuring the in-plane polarization using the IDEs with a 500 V-built-in ferroelectric tester (Precision Premier II model, Radiant Technologies). Hysteresis measurements were carried out based on a bipolar triangular wave excitation, and also remanent hysteresis measurements based on half triangular waves following the principle of the positive-up negative-down (PUND) method.<sup>[41]</sup> The frequency of the triangular wave excitation was set to 2 kHz for both measurement protocols. Temperature ( $T$ )-dependent polarization versus  $E$  field,  $P(E, T)$  curves, were measured on heating in a dedicated homemade cell allowing a maximum temperature of  $140^\circ\text{C}$ . Samples were immersed in a silicon oil bath during the polarization measurements to avoid electric discharges. The commonly used thermodynamic formulations based on Maxwell relations were applied to the  $P(E, T)$  data to derive the adiabatic temperature variation  $\Delta T$  characteristic of the ECE. As recommended in previous works,<sup>[45,46]</sup> only the upper branches with  $E > 0$  were used for the calculations. A polynomial was fitted to the isothermal  $P(E)$  curves so that all their data points occur at the same  $E$  field values, and then  $P(T)$  at the set of measured  $T$  val-

ues was transposed to give  $P(T)$  at the new set of  $E$  field values. Then, the derivative of  $P$  with respect to temperature was calculated from the experimental incremental values of polarization versus temperature ( $5\text{--}10^\circ\text{C}$  steps) at a given  $E$  value, and finally the analysis was completed through stepwise integration to derive the entropy variation of the ECE, namely,

$$\Delta S = \int_0^E \left( \frac{\partial P}{\partial T} \right)_{E'} dE' \quad (1)$$

for any field change  $\Delta E = E - 0$  as it is the current case. The adiabatic temperature variation can be calculated as well, namely,

$$\Delta T = -\frac{1}{\rho} \int_0^E \frac{T(E)}{c_p(E)} \left( \frac{\partial P}{\partial T} \right)_{E'} dE' \quad (2)$$

where  $\rho$  is the density and  $c_p$  the heat capacity of the material. As generally adopted for practical  $\Delta T$  calculations, both  $T$  and  $c_p$  are assumed  $E$  field independent.<sup>[46]</sup> Thus, Equation (2) can be simplified as

$$\Delta T \approx -\frac{T}{\rho c_p} \Delta S \quad (3)$$

The values  $\rho = 6\text{ g cm}^{-3}$  and  $c_p = 0.4\text{ J g}^{-1}\text{ K}^{-1}$  were used based on results from the previous study in bulk SBT05.<sup>[24]</sup> Despite that,  $c_p$  is both  $T$  and  $E$  field dependent, the adopted approach leads to a reasonable approximation of the ECE in the films, considering the weak dependence in the surveyed temperature range ( $25\text{--}142^\circ\text{C}$ ) and the fact that it is far from the ferroelectric  $T_C$  value ( $T_C \sim 285^\circ\text{C}$  for bulk SBT05<sup>[23,24]</sup>) where strong anomalies appear in  $c_p(T)$ .<sup>[46]</sup>

## Supporting Information

Supporting Information is available from the Wiley Online Library or from the author.

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## Conflict of Interest

The authors declare no conflict of interest.

## Data Availability Statement

The data that support the findings of this study are available from the corresponding author upon reasonable request.

## Keywords

aurivillius oxides, epitaxial thin films, ferroelectricity, pulsed laser deposition, solid-state electrocaloric cooling

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